

Supporting Information

Multi-shape active composites by 3D printing of digital shape memory polymers

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Table SI. The modeling parameters for three materials.

| | Fiber 1 | | Fiber 2 | | Matrix | |
|----------------|----------------|----------|----------------|----------|----------------|----------|
| Branch | E_{non} (Pa) | τ_i | E_{non} (Pa) | τ_i | E_{non} (Pa) | τ_i |
| E_1 | 1.7E+08 | 1E-07 | 3E+08 | 0.0001 | 1.96E+08 | 8.04E-06 |
| E_2 | 1.88E+08 | 9.93E-07 | 2.75E+08 | 0.000657 | 2.02E+08 | 9.28E-05 |
| E_3 | 2.12E+08 | 0.00001 | 2.96E+08 | 0.003872 | 2.4E+08 | 0.000827 |
| E_4 | 2.39E+08 | 9.08E-05 | 3.05E+08 | 0.02 | 2.7E+08 | 0.006032 |
| E_5 | 2.68E+08 | 0.00074 | 3.5E+08 | 0.1 | 2.92E+08 | 0.036577 |
| E_6 | 2.93E+08 | 0.005374 | 3.78E+08 | 0.576863 | 3.32E+08 | 0.860502 |
| E_7 | 3.08E+08 | 0.035368 | 2.92E+08 | 3.401616 | 3.03E+08 | 0.187428 |
| E_8 | 2.91E+08 | 0.2 | 2.15E+08 | 20 | 1.41E+08 | 4.728029 |
| E_9 | 2.85E+08 | 0.954957 | 1.47E+08 | 96.82391 | 13594410 | 83.13049 |
| E_{10} | 1.38E+08 | 3.182197 | 95213467 | 362.9461 | 505667.4 | 10000 |
| E_{11} | 1.62E+08 | 7.497457 | 63127650 | 1000 | 1158992 | 1848.755 |
| E_{12} | 1.78E+08 | 25.11365 | 62092100 | 2671.527 | 3453594 | 375.1723 |
| E_{13} | 1.53E+08 | 87.11596 | 52099306 | 7912.87 | 45511.49 | 935839.6 |
| E_{14} | 1.33E+08 | 283.7953 | 42374719 | 23498.79 | 50809648 | 20 |
| E_{15} | 1.22E+08 | 905.6253 | 35205449 | 71461.38 | 204851.1 | 67650.29 |
| E_{16} | 1.12E+08 | 3025.975 | 27897552 | 228551.6 | | |
| E_{17} | 98095537 | 10000 | 20760769 | 726401 | | |
| E_{18} | 83260945 | 32677.22 | 15532429 | 2277776 | | |
| E_{19} | 65704556 | 96510.16 | 11281878 | 7091525 | | |
| E_{20} | 59120212 | 267333.4 | 8305791 | 21997171 | | |
| E_{21} | 51922181 | 773277.7 | 5959708 | 68236585 | | |
| E_{22} | 44769327 | 2339554 | 4351312 | 2.08E+08 | | |
| E_{23} | 34599493 | 7613180 | 3329757 | 6.41E+08 | | |
| E_{24} | 21727122 | 26070126 | 2644468 | 2.07E+09 | | |
| E_{25} | 9995279 | 1E+08 | 2196711 | 7.07E+09 | | |
| E_{26} | 2916758 | 5.22E+08 | 1578065 | 2.4E+10 | | |
| E_{27} | 957137.7 | 5.77E+09 | 107012.2 | 1E+11 | | |
| T_g (°C) | 57 | | 38 | | 2 | |
| T_{ref} (°C) | 17 | | -3 | | -11 | |
| $C1$ | 17.44 | | 17.44 | | 11.44 | |
| $C2$ | 50.5 | | 42.1 | | 50.3 | |
| AF_c/k | -24000 | | -23000 | | -20000 | |
| E_{eq} (Pa) | 7.50E+06 | | 3.30E+06 | | 0.6*10^6 | |

Constitutive model and parameter characterization

To describe the thermomechanical behavior of the SMP material, the multi-branch model is used, in which one equilibrium branch and several thermoviscoelastic nonequilibrium branches are arranged in parallel. Maxwell elements are used in the nonequilibrium branches to represent the relaxation behavior of the material, and the total stress of the material can be expressed as:

$$\sigma_{total} = E_{eq}e + \sum_{m=1}^n E_{non}^m \int_0^t \frac{\partial e}{\partial s} \exp \left[- \int_s^t \frac{dt'}{\tau_m(T)} \right] ds, \quad (S1)$$

where E_{eq} is the Young's modulus of the equilibrium branch, E_{non}^m and τ_m are the Young's modulus and temperature dependent relaxation time of the m -th nonequilibrium branch. According to the time temperature superposition principle (TTSP), τ_m can be calculated using the relaxation time τ_m^R at reference temperature:

$$\tau_m(T) = a^{Shift}(T) \tau_m^R, \quad (S2)$$

where $a^{Shift}(T)$ is the temperature dependent shifting factor. According to O'Connell and McKenna, the shifting factors can be calculated by combining the Williams–Landel–Ferry (WLF) equation³³ and Arrhenius-type equation³⁴. When the temperature is higher than the reference temperature, the shifting factor can be expressed using the WLF equation:

$$\log[a^{Shift}(T)] = -\frac{C_1(T - T_{ref})}{C_2 + (T - T_{ref})}, \quad T > T_{ref}, \quad (S3)$$

where C_1 , C_2 and T_{ref} are the material parameters to be characterized. If the temperature is lower than the reference temperature T_{ref} , the shifting factor can be expressed by Arrhenius-type equation:

$$\log[a^{Shift}(T)] = -\frac{AF_c}{k^{Boltz}} \left(\frac{1}{T} - \frac{1}{T_{ref}} \right), \quad T < T_{ref}, \quad (S4)$$

where A , F_c , k^{Boltz} are the material constant, configurational energy and Boltzmann's constant respectively.

The DMA test results in Fig. 2 are used to identify the above parameters, including E_{eq} , E_{non}^m , τ_m^R , C_1 , C_2 , and AF_c/k^{Boltz} . The storage modulus at 90 °C can be considered as the equilibrium modulus E_{eq} of each material, as the relaxation time at this temperature in each nonequilibrium branch is minimal. Employing the nonlinear regression (NLREG) method^{35,36}, E_{non}^m , τ_m^R , C_1 , C_2 , and AF_c/k^{Boltz}

AF_c/k can be determined by fitting the $\tan \delta$ and storage modulus curves shown in Fig. 2. For the multi-branch linear model, the temperature dependent storage modulus $E_s(T)$, loss modulus $E_l(T)$ and loss factor $\tan \delta(T)$ can be respectively represented as

$$E_s(T) = E_{eq} + \sum_{m=1}^n \frac{E_m^{non} \omega^2 [\tau_m(T)]^2}{1 + \omega^2 [\tau_m(T)]^2}, \quad (\text{S5a})$$

$$E_l(T) = \sum_{m=1}^n \frac{E_m^{non} \omega \tau_m(T)}{1 + \omega^2 [\tau_m(T)]^2}, \quad (\text{S5b})$$

$$\tan \delta(T) = \frac{E_l(T)}{E_s(T)}, \quad (\text{S5c})$$

where ω is the test frequency.

The determined parameters are provided in the table in the supporting information. Figure S1 shows the comparison of the DMA curves between experiment and simulation for three testing materials. Good agreement indicates that these identified parameters can describe the thermomechanical behavior of the SMP materials very well.

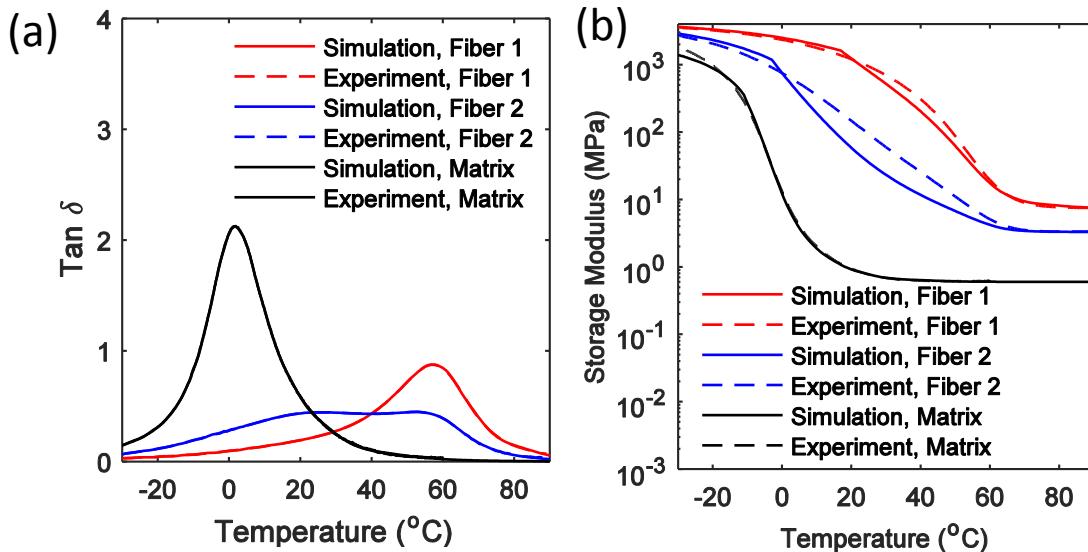


Figure S1. Comparison of the DMA curves between experiments and the simulation for three SMP materials.